

SPECIFICATION

AGM 2002G-801



MODLE NO:

AGM 2002G-801

DOC. FIRST ISSUE

RECORDS OF REVISION

| VERSION | DATE | REVISED PAGE NO. | SUMMARY |
|---------|------------|---------------------|------------------------|
| 0 | 2006/07/07 | | First issue |
| A | 2008/10/21 | | Modify Character |
| | | | Generator ROM Pattern |
| В | 2010/04/09 | | Correct pin19=A |
| С | 2012/08/15 | | Modify backlight |
| | | | information |
| D | 2013/07/10 | | Remove IC information. |

Contents

- 1.Precautions in use of LCD Modules
- 2.General Specification
- 3. Absolute Maximum Ratings
- 4. Electrical Characteristics
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- 9.Reliability
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- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

1.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8)AGT have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)AGT have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, AGT have the right to modify the version.)

2.General Specification

| Item | Dimension | Unit | | | | |
|----------------------|---|------|--|--|--|--|
| Number of Characters | 20 characters x 2Lines | _ | | | | |
| Module dimension | 180.0 x 40.0 x 13.9 (MAX) | mm | | | | |
| View area | 149.0 x 23.0 | mm | | | | |
| Active area | 142.8 x 20.64 | mm | | | | |
| Dot size | 1.12 x 1.12 | mm | | | | |
| Dot pitch | 1.22 x 1.22 | mm | | | | |
| Character size | 6.0 x 9.66 | mm | | | | |
| Character pitch | 7.2 x 10.98 | mm | | | | |
| LCD type | STN Negative, Blue Transmissive (In LCD production, It will occur slightly color can only guarantee the same color in the same be | | | | | |
| Duty | 1/16 | | | | | |
| View direction | 6 o'clock | | | | | |
| Backlight Type | LED, White | | | | | |
| IC | ST7066U | | | | | |

3.Absolute Maximum Ratings

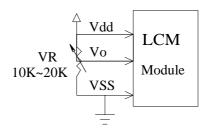
| Item | Symbol | Min | Тур | Max | Unit |
|--------------------------|--------------------------|----------|-----|----------|-------------------------|
| Operating Temperature | T_{OP} | -20 | _ | +70 | $^{\circ}\! \mathbb{C}$ |
| Storage Temperature | T_{ST} | -30 | _ | +80 | $^{\circ}\! \mathbb{C}$ |
| Input Voltage | V _I | V_{SS} | _ | V_{DD} | V |
| Supply Voltage For Logic | $ m V_{DD}	ext{-}V_{SS}$ | -0.3 | _ | 7 | V |
| Supply Voltage For LCD | V_{DD} - V_{o} | -0.3 | _ | 13 | V |

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4. Electrical Characteristics

| Item | Symbol | Condition | Min | Тур | Max | Unit |
|--------------------------|--------------------------------------|-----------------------|---------------------|------|-------------------|------|
| Supply Voltage For Logic | V_{DD} - V_{SS} | _ | 4.5 | 5.0 | 5.5 | V |
| Supply Voltage For LCD | | Ta=-20°C | _ | _ | 5.7 | V |
| *Note | V_{DD} - V_{0} | Ta=25°℃ | 4.2 | 4.35 | 4.5 | V |
| | | Ta=70°C | 3.5 | _ | _ | V |
| Input High Volt. | V_{IH} | _ | 0.7 V _{DD} | _ | V_{DD} | V |
| Input Low Volt. | $V_{\rm IL}$ | _ | Vss | _ | 0.6 | V |
| Output High Volt. | V_{OH} | _ | 3.9 | _ | V_{DD} | V |
| Output Low Volt. | V_{OL} | _ | 0 | _ | 0.4 | V |
| Supply Current | I_{DD} | V _{DD} =5.0V | 1.2 | 1.6 | 2.0 | mA |

^{*}Note: Please design the VOP adjustment circuit on customer's main board

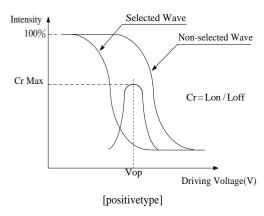


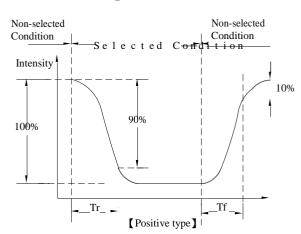
5.Optical Characteristics

| Item | Symbol | Condition | Min | Тур | Max | Unit |
|----------------|---------------|-----------|-----|-----|-----|----------------------|
| | θ | CR≧2 | 0 | _ | 20 | $\psi = 180^{\circ}$ |
| Wiery Angle | θ | CR≧2 | 0 | _ | 40 | $\Psi = 0^{\circ}$ |
| View Angle | θ | CR≧2 | 0 | _ | 30 | $\Psi = 90^{\circ}$ |
| | θ | CR≧2 | 0 | _ | 30 | $\psi = 270^{\circ}$ |
| Contrast Ratio | rast Ratio CR | | _ | 3 | _ | _ |
| Decrease Time | T rise | _ | _ | 150 | 200 | ms |
| Response Time | T fall | _ | _ | 150 | 200 | ms |

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)



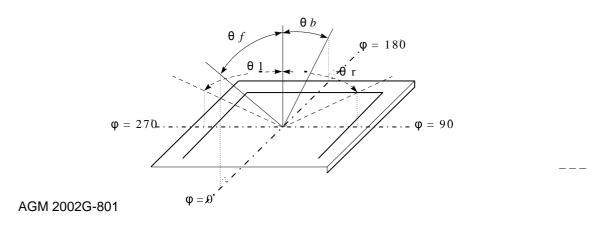


Conditions:

Operating Voltage : Vop Viewing Angle(θ , ϕ) : 0° , 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

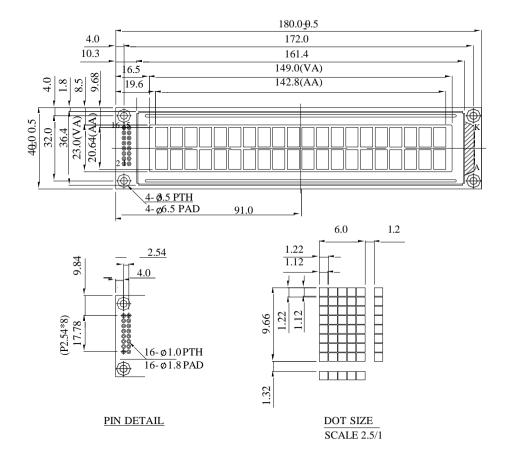
Definition of viewing angle(CR≥2)

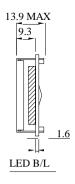


6.Interface Pin Function

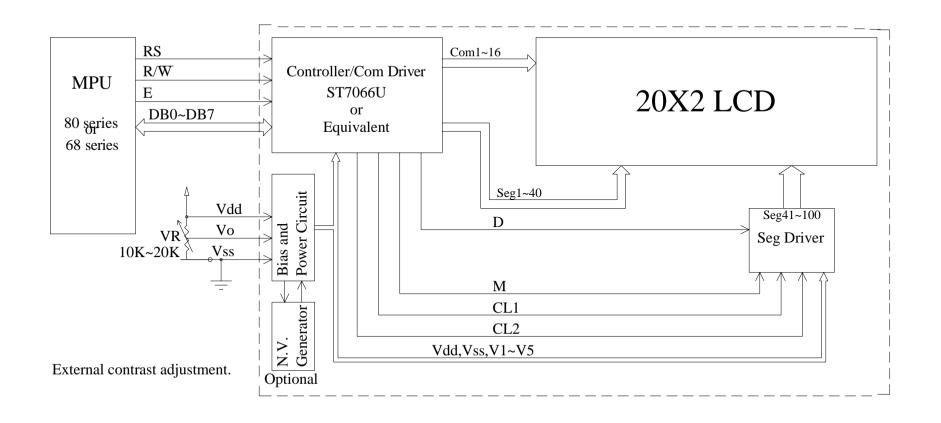
| Pin No. | Symbol | Level | Description |
|---------|-------------------|------------|--|
| 1 | V _{SS} | 0V | Ground |
| 2 | V_{DD} | 5.0V | Supply Voltage for logic |
| 3 | VO | (Variable) | Operating voltage for LCD |
| 4 | RS | H/L | H: DATA, L: Instruction code |
| 5 | R/W | H/L | H: Read(MPU→Module) L: Write(MPU→Module) |
| 6 | Е | Н,Н→L | Chip enable signal |
| 7 | DB0 | H/L | Data bus line |
| 8 | DB1 | H/L | Data bus line |
| 9 | DB2 | H/L | Data bus line |
| 10 | DB3 | H/L | Data bus line |
| 11 | DB4 | H/L | Data bus line |
| 12 | DB5 | H/L | Data bus line |
| 13 | DB6 | H/L | Data bus line |
| 14 | DB7 | H/L | Data bus line |
| 15 | A | | Power supply for B/L + |
| 16 | K | | Power supply for B/L - |

7.Contour Drawing & Block Diagram





| PIN NO. | SYMBOL |
|---------|--------|
| 1 | Vss |
| 2 | Vdd |
| 3 | Vo |
| 4 | RS |
| 5 | R/W |
| 6 | Е |
| 7 | DB0 |
| 8 | DB1 |
| 9 | DB2 |
| 10 | DB3 |
| 11 | DB4 |
| 12 | DB5 |
| 13 | DB6 |
| 14 | DB7 |
| 15 | A |
| 16 | K |



Character located DDRAM address

DDRAM address

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F 10 11 12 13 40 41 42 43 44 45 46 47 48 49 4A 4B 4C 4D 4E 4F 50 51 52 53

8.Character Generator ROM Pattern

Table.2

| | | _ | | | | | | | | | | | | | | |
|-------------------------|------------------|------|--|--|---|--|--|--|--------|--------|--|---|--|--|--|---|
| Upper 4 bit Lower | LLLL | LLLH | LLHL L | LHH LH | LL LHI | LH LHH | L LHHI | H HLLL | HLLH : | HLHL H | LHH H | HLL HE | ІГН НН | нь нні | НН | |
| 4 bit | | | | | | | | | | | | | | | | |
| LLLL | CG RAM (1) | | | | | 44444444444444444444444444444444444444 | 55 | 5555 5 5 5 | | | | ***** | 55 55 5 5 55 5 55 5 55 | **** | about of a of a of a of a | chthathatha g g g g g g atha |
| LLLH | (2) | | के विवेदित | 555 255 255 255 | 55 55 55 55 55 55 55 55 55 55 | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | 555 5555 5555 | 55 5 5555 5555 | | | 20 20 20 20 20 20 | 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | 5555 5555 55555 5555 | \$ \$ \$ \$ \$ | \$ \$ \$ \$\$\$ \$\$\$\$ \$\$\$\$ \$\$\$\$ | CANAMANA |
| LLHL | (3) | | deter | \$ \$ \$ \$ \$ \$ | 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | | 44444 4444 4444 4444 | \$ \$ \$ \$ \$ \$ | | | 5666 5666 5666 5666 5666 5666 5666 566 | 4 4 4 4 4 4 | # ### # #### ##### | ## ## ### | ##### ##### ##### ###### ############# | Party |
| LLHH | (4) | | \$ | ###################################### | | 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 | 2000 2000 2000 2000 | 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 | | | *5 | 444 444 444 444 444 444 | 5 555 5555 5 | 5 55555 55555 | *5 | |
| LHLL | (5) | | ************************************** | | | \$5 55 55 55 55 55 55 55 | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | ************************************** | | | 5 5 5 | ************* | 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | | 25552 |
| LHLH | (6) | | ************************************** | | | 44 444 | \$ \$5 \$ \$ | *5 | | | | ************************************** | 10 10 10 10 10 10 10 10 10 10 10 10 10 1 | 10 m | AND THE PARTY OF T | |
| | (5) | | \$ 55 5 55 5 55 | ************************************** | 55555 55555 | | ************************************** | 5 55 5 55 5 55 5 55 | | | 19 19 19 19 19 19 19 19 19 19 19 19 19 1 | 4 4 4 4 4 4 4 4 4 4 4 | ************************************** | ************************************** | 1944 1944 1944 1944 1944 1944 1944 1944 | ### - #### |
| | (7) | | | | 100 100 100 100 100 100 100 100 100 100 | ##### # # ##### | ###### # # # # # # | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | | | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | 555 5555 | \$\$\$\$\$ \$ \$\$\$\$\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | Marketer P P P P P P P P P P P P P P P P P P P | 25555 55 2555 2555 2555 2555 2555 2555 |
| LHHH | (8) | | 15 15 15 | **** | | ************************************** | 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 | | | | 50005 5 | ************************************** | ಕ್ರಕ್ಕೆಕ್ ಕ್ರಿಕ್ಕೆ ಕ್ರಿಕ್ಕೆ | 555 5555 5 | | ARRES HARE |
| HLLL | (1) | | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | 10 10 10 10 10 10 10 10 10 10 10 10 10 1 | 950 950 | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | \$ 5 5 5 \$ 5 5 5 \$ 5 5 5 | | | | 44 44 44 44 44 44 44 44 44 44 44 44 44 | ************************************** | सम्बद्धाः सम्बद्धाः स | | ************************************** |
| | | | - P- | | 44 4 4 4 4 | | 44 4 444 444 4 444 | \$ \$ \$ | | | 1년 6 1년 1년 6년 1년 | 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | ත් මේතී ක්ෂේකීමේ | ਵਿੱਚ ਵਿੱਚੋਂ | 5 B | ARAR |
| HLHL | (3) | | ************************************** | # # # # # # # # # # # # # # # # # # # | 444 | \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ | ###################################### | ******************************* | | | | 4 4 4 4 4 | ***** | 'd'd' d'd'd | P. 444 | |
| | | | | | 5 5 | 5 | 5 5 | 2000 | | | ************************************** | ###################################### | _ | | | 15 |
| HLHH | (4) | | 5 5 55555 5 | ************************************** | | ************************************** | ######### # # # # # # | 10 mm | | | # # # # # # # # # | | 5 55555 5 5 5 | 55555555555555555555555555555555555555 | ***** | 24444 24444 24444 24444 |
| HHLL | (5) | | *5 *5 *5 | ** *** *** | ************************************** | 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 | 4 4444444 4 | ತಿ ತೆತೆತೆತೆತೆ | | | ያ ያ ያ ያ ያ | 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | ************************************** | 4 44 4 44 4 44 4 44 4 44 4 44 4 44 4 4 | offer offerfield offerfield offerfield offerfield offerfield offerfield | CARACATA CARACA CARACA CARACATA CARACATA |
| | | | 55555 | ****************************** | ************************************** | ****** | ##### ##### ########################## | 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | | | 2 2 2 3 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | ************************************** | ************************************** | ************************************** | | 55555 5 |
| ннН | (6) | | 15 15 15 15 15 15 15 15 15 15 15 15 15 1 | 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 | 444444 4 4 4 4 4 4 | 5 5 5 5 | ************************************** | ** | | | 55 55 55 55 55 55 55 55 55 55 55 55 55 | 5555 5555 5555 5555 | 5555 5555 5555 5555 | 5 5 5 5 | charach charach charach charach | |
| | | | - 5 5 | 5 5 5 5 | 55 55 55 55 55 55 55 55 55 55 | *** | #### ################################# | ************************************** | | | 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | | 55555 5 5 5 | 555 555 555 | 5 5 5 5 5 5 5 5 5 5 5 | ARARARARA ARARARARA ARARARARA ARARARARA |

9. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

| | Environmental Test | | |
|---------------------------------------|---|---|------|
| Test Item | Content of Test | Test Condition | Note |
| High Temperature storage | Endurance test applying the high storage temperature for a long time. | 80°C 200hrs | 2 |
| Low Temperature storage | Endurance test applying the low storage temperature for a long time. | -30°C 200hrs | 1,2 |
| High Temperature Operation | Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time. | 70°C 200hrs | |
| Low Temperature Operation | Endurance test applying the electric stress under low temperature for a long time. | -20°C 200hrs | 1 |
| High Temperature/ Humidity storage | The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature. | 60°C,90%RH 96hrs | 1,2 |
| Thermal shock resistance | The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min cycle | -20°C/70°C 10 cycles | |
| Vibration test | Endurance test applying the vibration during transportation and using. | Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes | 3 |
| Static electricity test | Endurance test applying the electric stress to the terminal. | VS=800V,RS=1.5k Ω CS=100pF 1 time | |

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

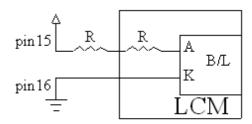
Specification

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNIT | TEST CONDITION |
|------------------------------------|--------|-----|-----|-----|-------------------|---|
| Supply Current | ILED | - | 48 | 60 | mA | V=3.5V |
| Supply Voltage | v | 3.4 | 3.5 | 3.6 | V | - |
| Reverse Voltage | VR | - | - | 5 | V | - |
| Luminance (Without LCD) | IV | 344 | 429 | - | CD/M ² | ILED=48mA |
| LED Life Time (For Reference only) | - | - | 50K | - | Hr. | ILED=48mA 25°C,50-60%RH, (Note 1) |
| Color | White | 1 | | 1 | • | |

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

2.Drive from pin15,pin16



(Will never get Vee output from pin15)

11.Inspection specification

| NO | Item | Criterion | | | | AQL | | |
|----|---|---|--------------------------------|--|--|-----|--|--|
| 01 | Electrical Testing | Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect. | | | | | | |
| 02 | Black or white spots on LCD (display only) | 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm | | | | | | |
| 03 | LCD black spots, white spots, contamination (non-display) | 3.1 Round type $\Phi=(x+y)/2$ X 3.2 Line type: | ↓ ↑ Y | SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ | Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2 As round type | 2.5 | | |
| 04 | Polarizer bubbles | If bubbles are v judge using bla specifications, to to find, must ch specify direction | ck spot not easy neck in | Size Φ $ Φ \le 0.20 $ $ 0.20 < Φ \le 0.50 $ $ 0.50 < Φ \le 1.00 $ $ 1.00 < Φ $ $ Total Q TY$ | Acceptable Q TY Accept no dense 3 2 0 3 | 2.5 | | |

| NO | Item | Criterion | | | AQL |
|----|-----------|--------------------------|---|---|-----|
| 05 | Scratches | Follow NO.3 LCD blace | ck spots, white spots, co | ontamination | |
| | | Symbols Define: | | | |
| | | x: Chip length y | z: Chip width z: Cl | hip thickness | |
| | | k: Seal width t | : Glass thickness a: Lo | CD side length | |
| | | L: Electrode pad lengtl | n: | | |
| | | | | | |
| | | 6.1 General glass chip | : | | |
| | | 6.1.1 Chip on panel sur | rface and crack betweer | n panels: | |
| | | | N A A A A A A A A A A A A A A A A A A A | THE REPORT OF THE PARTY OF THE | |
| | | z: Chip thickness | y: Chip width | x: Chip length | |
| | | Z≦1/2t | Not over viewing | x ≤ 1/8a | |
| 06 | Chipped | | area | | 2.5 |
| | glass | $1/2t < z \leq 2t$ | Not exceed 1/3k | $x \leq 1/8a$ | |
| | | 6.1.2 Corner crack: | e chips, x is total length | | |
| | | z: Chip thickness | y: Chip width | x: Chip length | |
| | | Z≦1/2t | Not over viewing area | x≤1/8a | |
| | | $1/2t < z \leq 2t$ | Not exceed 1/3k | x≤1/8a | |
| | | ¹⊙ If there are 2 or mor | e chips, x is the total ler | rigth of each chip. | |

| NO | Item | Criterion | | | AQL |
|----|----------------|--|--------------|---------------------------------|-----|
| | nem | Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad: | | | |
| | | $y \le 0.5$ mm $x \le 1/8$ | | z: Chip thickness $0 < z \le t$ | |
| 06 | Glass crack | 6.2.2 Non-conductive portion: | | | 2.5 |
| | | y: Chip width x: 0 | Chip length | z: Chip thickness | |
| | | $y \le L$ $x \le$ | 1/8a | $0 < z \le t$ | |
| | | ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged. 6.2.3 Substrate protuberance and internal crack. | | | |
| | | X | y: width | x: length | |
| | | | $y \le 1/3L$ | $x \leq a$ | |
| | | у | | | |

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| NO | Item | Criterion | AQL |
|----|---------------|---|------|
| 07 | Cracked glass | The LCD with extensive crack is not acceptable. | 2.5 |
| 08 | | 8.1 Illumination source flickers when lit. | |
| | Backlight | 8.2 Spots or scratched that appear when lit must be judged. | |
| | elements | Using LCD spot, lines and contamination standards. | |
| | | 8.3 Backlight doesn't light or color wrong. | 0.65 |
| | Bezel | 9.1 Bezel may not have rust, be deformed or have fingerprints, | |
| 09 | | stains or other contamination. | |
| | | 9.2 Bezel must comply with job specifications. | 0.65 |
| | | 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. | 2.5 |
| | | 10.2 COB seal surface may not have pinholes through to the IC. | |
| | | 10.3 The height of the COB should not exceed the height | 0.65 |
| | | indicated in the assembly diagram. | |
| | | 10.4 There may not be more than 2mm of sealant outside the | 2.5 |
| | | seal area on the PCB. And there should be no more than three places. | |
| | | 10.5 No oxidation or contamination PCB terminals. | 2.5 |
| 10 | PCB · COB | 10.6 Parts on PCB must be the same as on the production | 0.65 |
| 10 | PCB · COB | characteristic chart. There should be no wrong parts, missing parts or excess parts. | |
| | | 10.7 The jumper on the PCB should conform to the product characteristic chart. | 0.65 |
| | | 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. | 2.5 |
| | | 10.9 The Scraping testing standard for Copper Coating of PCB | 2.5 |
| | | X * Y<=2mm2 | |
| 11 | | 11.1 No un-melted solder paste may be present on the PCB. | 2.5 |
| | | 11.2 No cold solder joints, missing solder connections, | 2.5 |
| | Soldering | oxidation or icicle. | |
| | | 11.3 No residue or solder balls on PCB. | 2.5 |
| | | 11.4 No short circuits in components on PCB. | 0.65 |

| NO | Item | Criterion | AQL |
|----|------------|--|------|
| | | 12.1 No oxidation, contamination, curves or, bends on interface | 2.5 |
| | | Pin (OLB) of TCP. | |
| | | 122 No cracks on interface pin (OLB) of TCP. | 0.65 |
| | | 12.3 No contamination, solder residue or solder balls on product. | 2.5 |
| | | 12.4 The IC on the TCP may not be damaged, circuits. | 2.5 |
| | | 12.5 The uppermost edge of the protective strip on the interface | 2.5 |
| | | pin must be present or look as if it cause the interface pin to sever. | |
| | General | 12.6 The residual rosin or tin oil of soldering (component or chip | 2.5 |
| 12 | | component) is not burned into brown or black color. | |
| | appearance | 12.7 Sealant on top of the ITO circuit has not hardened. | 2.5 |
| | | 12.8 Pin type must match type in specification sheet. | 0.65 |
| | | 12.9 LCD pin loose or missing pins. | 0.65 |
| | | 12.10 Product packaging must the same as specified on packaging | 0.65 |
| | | specification sheet. | |
| | | 12.11 Product dimension and structure must conform to product | 0.65 |
| | | specification sheet. | |
| | | 12.12 Visual defect outside of VA is not considered to be rejection. | 0.65 |

12.Material List of Components for RoHs

1. AGTECHNOLOGIES hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

| Material | (Cd) | (Pb) | (Hg) | (Cr6+) | PBBs | PBDEs |
|--|------------|-------------|-------------|-------------|-------------|-------------|
| Limited Value | 100 ppm | 1000 ppm | 1000 ppm | 1000 ppm | 1000 ppm | 1000 ppm |
| Above limited value is set up according to RoHS. | | | | | | |

2. Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. : Reflow :

 250° C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}\mathbb{C}$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.